

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Miniature 10 Amps • 4PDT **To MIL-PRF-83536 DC Suppressed Coils**

SPECIFICATIONS

GENERAL

Contact Arrangement4PDT (4 Form C) Weight......3.0 oz approx. Designed to meet the requirements of MIL-PRF-83536 PERFORMANCE Contact Rating (Note 1):

115/208V 400 Hz (Case Grounded) Inductive8 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded) 2.5 Amps @ 115/208V 60 Hz (Case Grounded)

115/208V 400 Hz (Case Grounded) 2 Amps @ 115/208V 60 Hz (Case Grounded) Lamp2 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded)

1.5 Amps @ 115/208V 60 Hz

(Case Grounded)

resistive load, 125°C Pull In Power500 mw approx.

DC Coil Operate/Release Time: 15 ms max

Excluding bounce time at nominal coil voltage

Contact Bounce Time...... 1 ms max @ rated contact load, 28 VDC

Contact Voltage Drop:

Before Life150 mv max @ 10 Amps and 6 VDC After Life175 mv max @ 10 Amps

and 6 VDC

ENVIRONMENTAL

Temperature Range-70°C to +125°C 30 G's 70 - 3,000 Hz Shock (Operating)(Note 2)200 G's 6 ms

ELECTRICAL CHARACTERISTICS

Duty CycleContinuous Insulation Resistance......100 megohms @ 500V 25°C

Dielectric Strength:

Sea Level:

Contact to Case	1,250 VRMS
Contact to Coil	1,250 VRMS
Coil to Case	1,000 VRMS
Across Open Contacts	1,250 VRMS
,000 Feet:	
All Points	350 VRMS

MIL-PRF-83536/16 QUALIFIED to ER level M

Notes

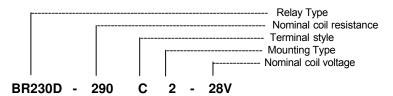
- 1. For other ratings consult the factory.
- 2. For applications requiring higher shock and vibration, consult the factory.

3. AC coil line frequency 50 to 400 Hz.



COIL DATA

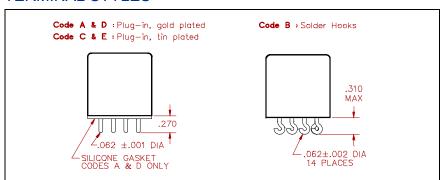
MODEL BR230D PART NUMBER	BR230D-20()()-6V	BR230D-78()()-12V	BR230D-290()()-28V	BR230D-890()()-48V
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	28 VDC	48 VDC
MAXIMUM COIL VOLTAGE	8 VDC	15 VDC	29 VDC	59 VDC
PULL IN VOLTAGE (MAX @ +125°C)	4.5 VDC	9 VDC	18 VDC	36 VDC
DROP OUT VOLTAGE (MAX)	1.8 VDC	3.5 VDC	5.1 VDC	11 VDC
MAXIMUM BACK EMF	9 VDC	18 VDC	42 VDC	72 VDC
COIL RESISTANCE ± 10% @ 25°C	20 OHMS	78 OHMS	290 OHMS	890 OHMS



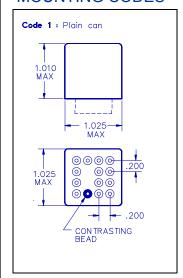
SCHEMATIC TERMINAL VIEWS

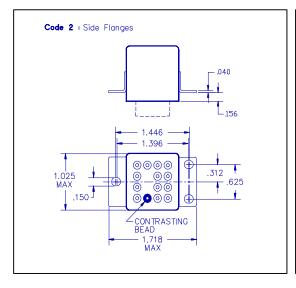
D1 -X2 D2 D3 O O O O C1 C2 C3 H B1 B2 B3 O O O A1 +X1 A2 A3

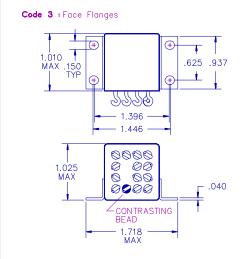
TERMINAL STYLES



MOUNTING CODES







GENERAL NOTES

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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